

## Electronic Patent Application Fee Transmittal

Application Number:	10672778
Filing Date:	26-Sep-2003
Title of Invention:	Atomic layer deposition (ALD) method with enhanced deposition rate
First Named Inventor:	Chih-Ta Wu
Filer:	Daniel R. McClure
Attorney Docket Number:	252016-3000

Filed as Large Entity

### Utility Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Basic Filing:

Pages:

Claims:

Claims in excess of 20	1202	1	50	50
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Miscellaneous-Filing:

Petition:

Patent-Appeals-and-Interference:

Post-Allowance-and-Post-Issuance:

Extension-of-Time:

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Miscellaneous:</b>				
<b>Total in USD (\$)</b>				<b>50</b>